

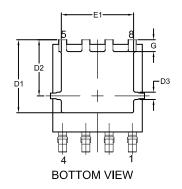
**DATE 13 AUG 2019** 

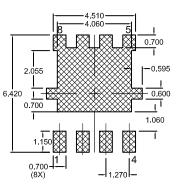
#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M. 1994.
- CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.150mm PER SIDE.
- DIMENSIONS D AND E ARE **DETERMINED AT THE OUTERMOST** EXTREMES OF THE PLASTIC BODY.
- DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.
- OPTIONAL MOLD FEATURE.

MILLIMETERS				
DIM	MIN	NOM	MAX	
Α	1.10	1.20	1.30	
A1	0.00	80.0	0.15	
A2	1.10	1.15	1.20	
A3	0.25 REF			
A4	0.45	0.50	0.55	
b	0.40	0.45	0.50	
С	0.19	0.22	0.25	
c2	0.19	0.22	0.25	
D	4.70	4.80	4.90	
D1	3.80	4.00	4.20	
D2	3.00	3.10	3.20	
D3	0.30	0.40	0.50	
Е	4.80	4.90	5.00	
E1	3.90	4.00	4.10	
E2	5.00	5.15	5.30	
е	1.27 BSC			
G	0.55	0.65	0.75	
Н	6.00	6.15	6.30	
L	0.45	0.65	0.85	
L1	0.15	0.25	0.35	
L2	0.90	1.10	1.30	
q	0°	4°	8°	

## DETAIL 'A'

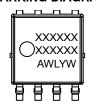




# RECOMMENDED LAND PAD

\*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

### **GENERIC MARKING DIAGRAM\***



XXXXXX = Specific Device Code

= Assembly Location

= Wafer Lot WL Υ = Year W = Work Week

\*This information is generic. Please refer to device data sheet for actual part marking. Some products may not follow the Generic Marking.

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DESCRIPTION:	LFPAK8 5x6		PAGE 1 OF 1	

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